

EUT PHOTO

Report No.: AGC01662180503AP02

FCC ID : SRMT11012820
PRODUCT DESIGNATION : 3G, 2G Tracking Device
BRAND NAME : N/A
MODEL NAME : T11012820
MANUFACTURER : Sensitech, INC.
DATE OF ISSUE : Aug. 13, 2018
REPORT VERSION : V1.1

Attestation of Global Compliance (Shenzhen) Co., Ltd

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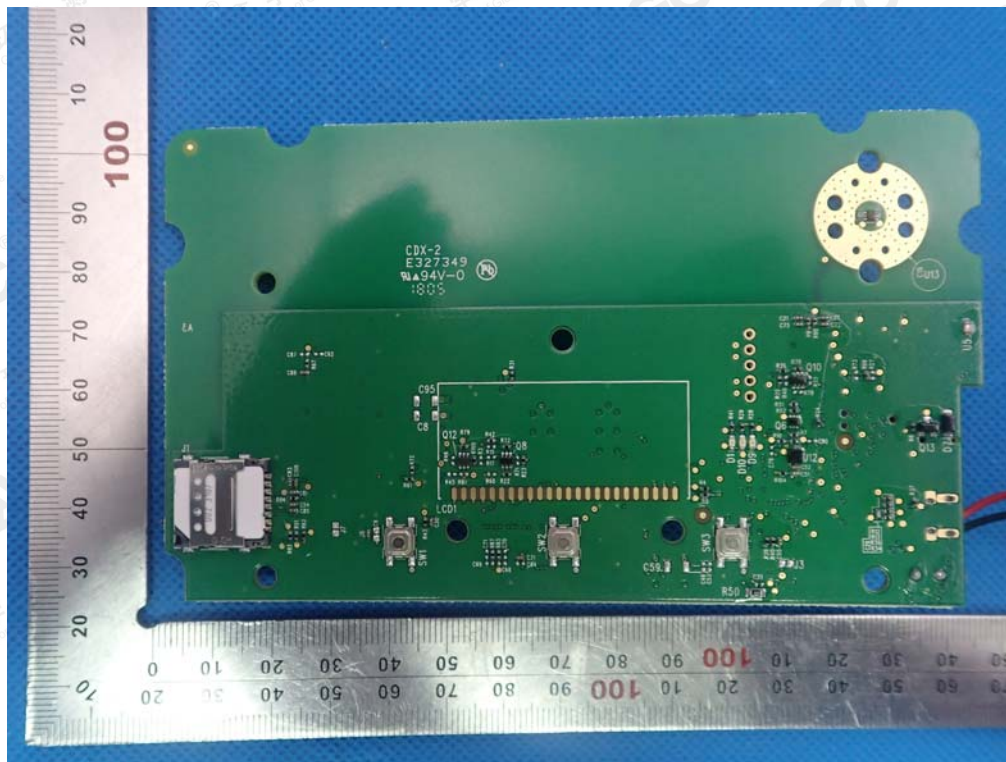
Report Revise Record

Report Version	Revise Time	Issued Date	Valid Version	Notes
V1.0	/	July 16, 2018	Invalid	Initial Release
V1.1	1 st	Aug. 13, 2018	Valid	Revise Report

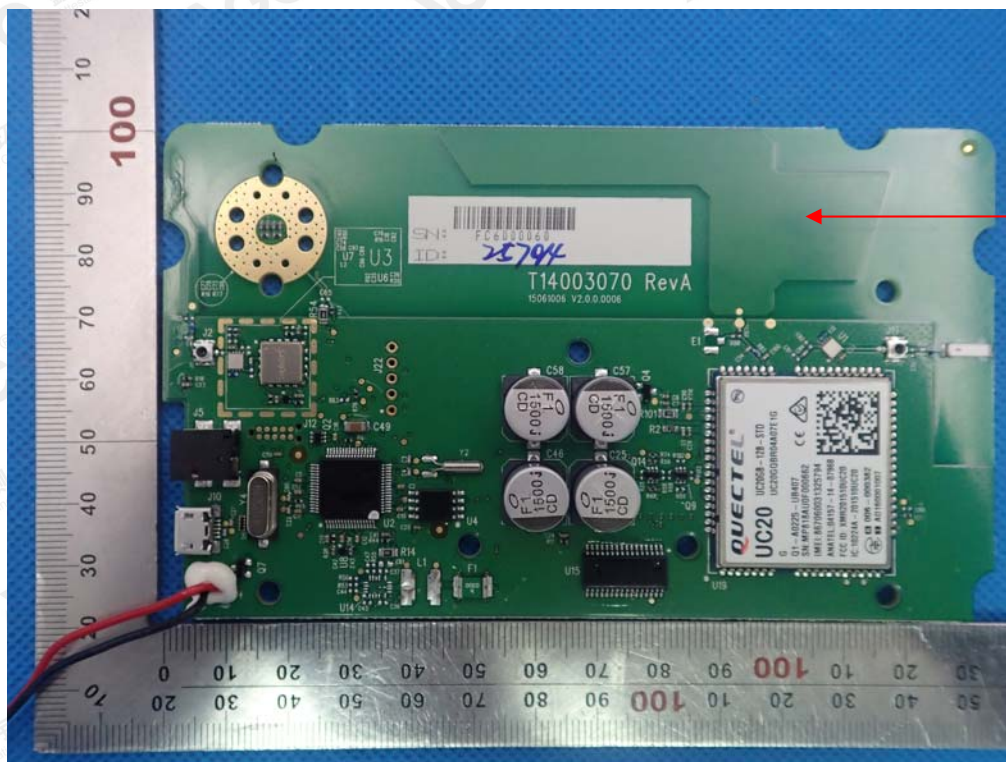
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PHOTO GRAPHS OF EUT

INTERNAL VIEW OF EUT(FIGURE 1)



INTERNAL VIEW OF EUT(FIGURE 2)



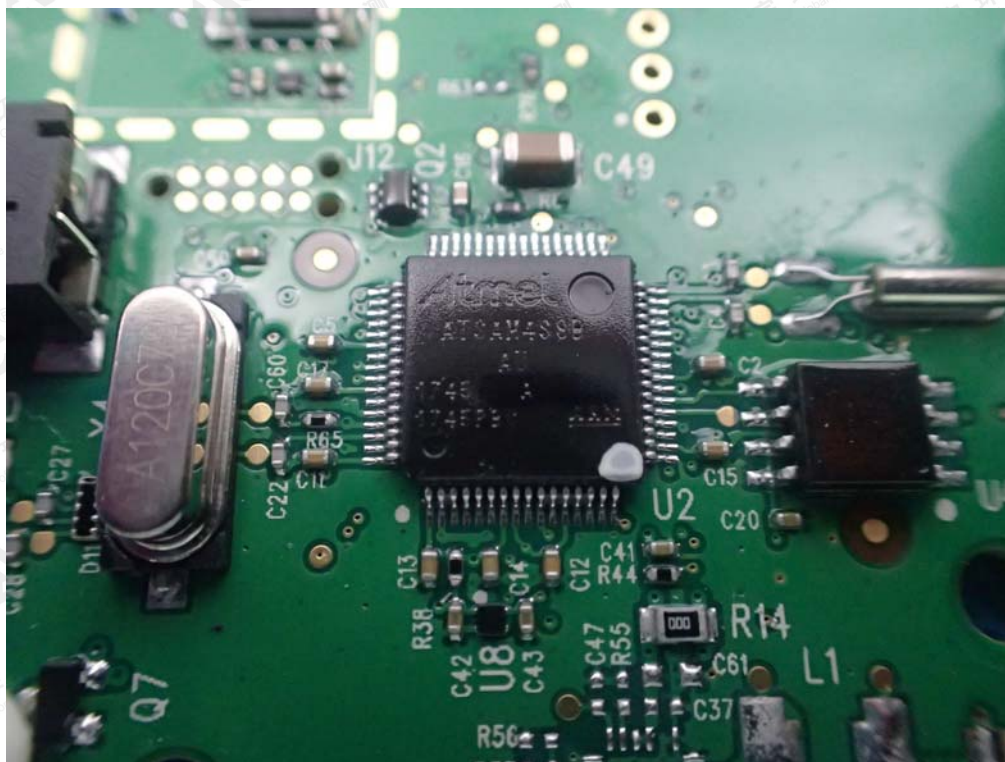
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A close-up photograph of a Qualcomm MDM6200 mobile processor mounted on a blue printed circuit board (PCB). The processor is a large, dark, square chip with gold wire bonds. The text on the chip includes "QUALCOMM®", "MDM6200", "AE744SJF", and "E0744007". Below the main chip, there is a smaller chip labeled "ESMT" with "FM64D1G12A", "XZS1 -5BAE", and "M70ACJ 729". To the right of the main chip, there is another chip labeled "PM6015" with "CU73627Y" and "U0736000". Various other components, including capacitors and smaller chips, are visible on the PCB.

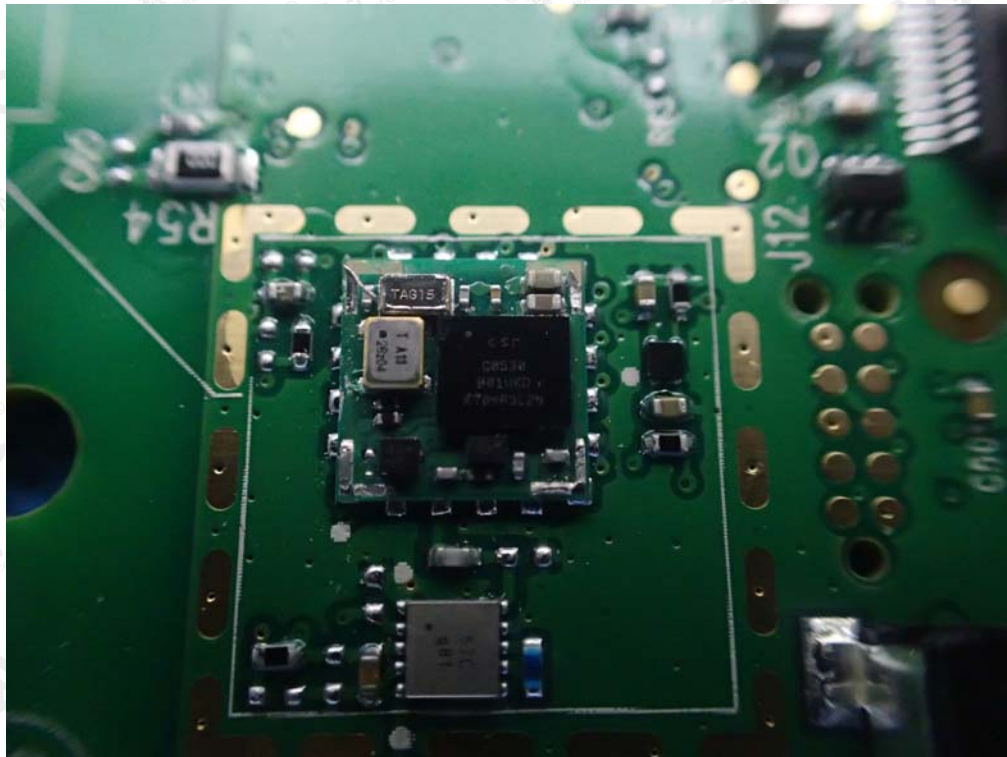
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INTERNAL VIEW OF EUT(FIGURE 5)



INTERNAL VIEW OF EUT(FIGURE 6)



----END OF REPORT----

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